# NOT RECOMMENDED FOR NEW DESIGN USE DMC2710UDWQ



DMG1016UDWQ

#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

#### **Product Summary**

Device	BVDSS	Rds(on)	I <sub>D</sub> @T <sub>A</sub> = +25°C
Q1	20V	$0.45\Omega$ @ V <sub>GS</sub> = $4.5V$	1066mA
Q2	-20V	0.75Ω @ Vgs = -4.5V	-845mA

#### **Description**

This new generation MOSFET has been designed to minimize the onstate resistance ( $R_{DS(ON)}$ ) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

- Battery operated systems and solid-state relays
- Drivers: relays, solenoids, lamps, hammers, displays, memories, transistors, etc.
- Power supply converter circuits

### **Features and Benefits**

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMG1016UDWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

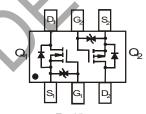
https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Package: SOT363
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)







Top View Internal Schematic

## Ordering Information (Note 4)

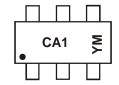
		•			
Part Number	har Compliance Books		Packing		
Part Number	Compliance	Package	Qty.	Carrier	
DMG1016UDWQ-7	Automotive	SOT363	3000	Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and
- <1000ppm antimony compounds.

  4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**



 $\begin{array}{l} \text{CA1} = \underbrace{Product\ Type\ Marking\ Code}\\ \text{YM\ or\ } \overline{Y}\text{M=} \ Date\ Code\ Marking}\\ \text{Y\ or\ } \overline{Y} = \text{Year\ } (ex:\ J=2022)\\ \text{M=} \ Month\ } (ex:\ 9=\text{September}) \end{array}$ 

#### Date Code Key

Year	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033
Code	J	K	L	М	N	0	Р	R	S	T	U	V
Month	lon	Feb	Mar	Apr	May	lun	Jul	Aug	Sep	Oct	Nov	Dec
WOITH	Jan	reb	IVIAI	Aþi	iviay	Jun	Jui	Aug	ОСР	001	1404	Dec



# Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 5)	PD	330	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θ</sub> JA	379	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

## Maximum Ratings N-CHANNEL – Q1 (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage			VDSS	20	V
Gate-Source Voltage			Vgss	<b>±</b> 6	V
Continuous Drain Current (Note 5)	Steady State	T <sub>A</sub> = +25°C T <sub>A</sub> = +85°C	lo	1066 690	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	3.2	А

### Maximum Ratings P-CHANNEL - Q2 (@TA = +25°C, unless otherwise specified.)

Characteristic				Symbol	Value	Unit
Drain-Source Voltage				Voss	-20	V
Gate-Source Voltage		. 1		V <sub>GSS</sub>	±6	V
Continuous Drain Current (Note 5)	Steady State	TA = +25°C TA = +85°C		l <sub>D</sub>	-845 -548	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 19	%)			IDM	-2.2	Α

# Electrical Characteristics N-CHANNEL - Q1 (@TA = +25°C, unless otherwise specified.)

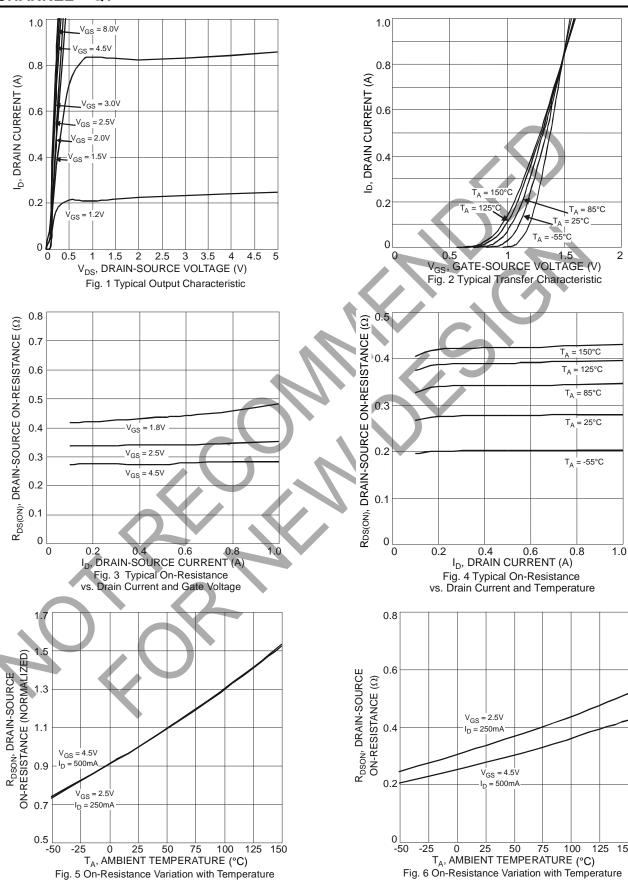
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)		1 - 1				
Drain-Source Breakdown Voltage	BVDSS	20		_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current @Tc = +25°C	IDSS		_	100	nA	V <sub>DS</sub> =20V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±1.0	μΑ	$V_{GS} = \pm 4.5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)						
Gate Threshold Voltage	VGS(TH)	0.5	_	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
			0.3	0.45		V <sub>G</sub> S = 4.5V, I <sub>D</sub> = 600mA
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	0.4	0.6	Ω	$V_{GS} = 2.5V, I_D = 500mA$
			0.5	0.75		V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 350mA
Forward Transfer Admittance	Y <sub>fs</sub>	_	1.4	_	S	V <sub>DS</sub> = 10V, I <sub>D</sub> = 400mA
Diode Forward Voltage (Note 6)	V <sub>SD</sub>	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 150mA$
DYNAMIC CHARACTERISTICS (Note 7)						
Input Capacitance	Ciss	_	60.67	_	pF	
Output Capacitance	Coss	_	9.68	_	pF	V <sub>DS</sub> = 10V, V <sub>GS</sub> = 0V, f = 1.0MHz
Reverse Transfer Capacitance	Crss	_	5.37	_	pF	-1 = 1.0ivii iz
Total Gate Charge	Qg	_	736.6	_	nC	
Gate-Source Charge	Qgs	_	93.6	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250 \text{mA}$
Gate-Drain Charge	Qgd	_	116.6	_	nC	- ID = 230IIIA
Turn-On Delay Time	t <sub>D(ON)</sub>	_	5.1	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	7.4	_	ns	$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	tD(OFF)	_	26.7	_	ns	$R_L = 47\Omega$ , $R_G = 10\Omega$
Turn-Off Fall Time	tF	_	12.3	_	ns	

Notes: 5. Device mounted on FR-4 PCB with minimum recommended pad layout.

Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.

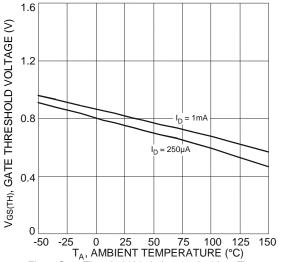


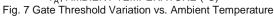
#### N-CHANNEL - Q1

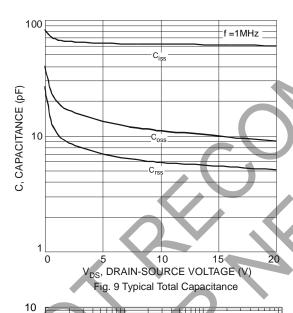




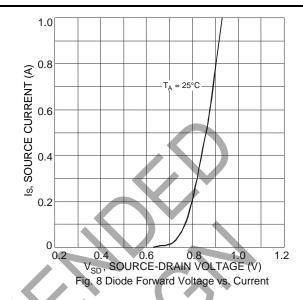
# N-CHANNEL - Q1 (continued)







V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 11. SOA, Safe Operation Area



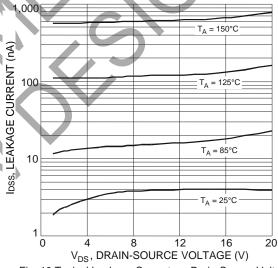
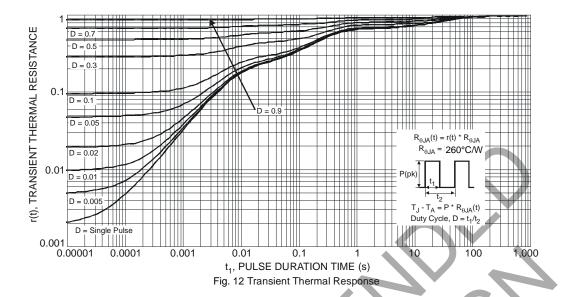


Fig. 10 Typical Leakage Current vs. Drain-Source Voltage







# Electrical Characteristics P-CHANNEL – Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

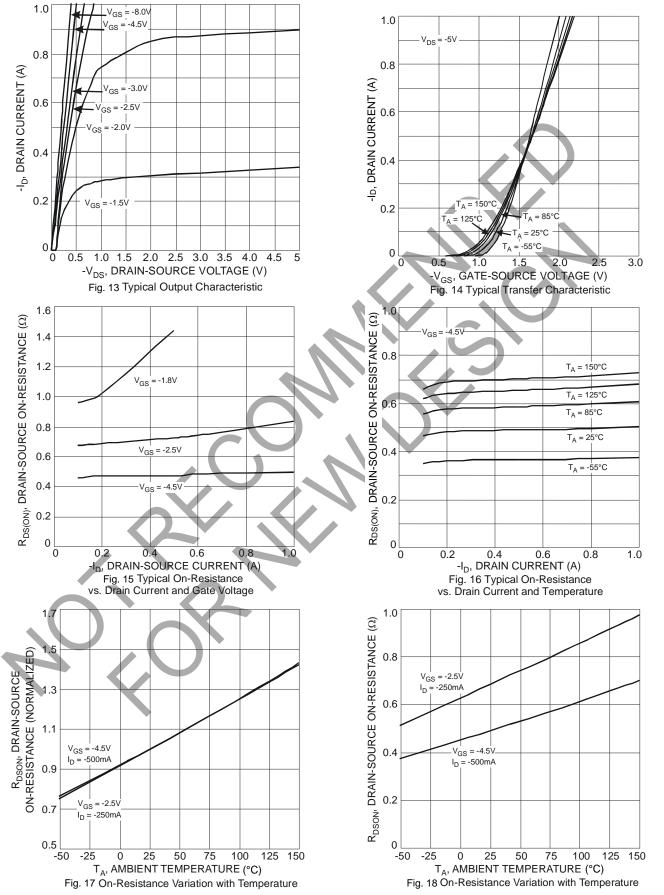
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)							
Drain-Source Breakdown Voltage		$BV_DSS$	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	©T <sub>C</sub> = +25°C	I <sub>DSS</sub>	_	_	-100	nA	V <sub>DS</sub> = -20V, V <sub>GS</sub> = 0V
Gate-Source Leakage		I <sub>GSS</sub>	_	_	±2.0	μΑ	$V_{GS} = \pm 4.5V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 6)							
Gate Threshold Voltage		Vgs(th)	-0.5	1	-1.0	٧	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$
				0.5	0.75		$V_{GS} = -4.5V$ , $I_{D} = -430mA$
Static Drain-Source On-Resistance		RDS(ON)	_	0.7	1.05	Ω	$V_{GS} = -2.5V, I_{D} = -300mA$
				1.0	1.5		Vgs = -1.8V, I <sub>D</sub> = -150mA
Forward Transfer Admittance		Y <sub>fs</sub>	_	0.9	1	S	V <sub>DS</sub> = -10V, I <sub>D</sub> = -250mA
Diode Forward Voltage (Note 6)		VsD	_	-0.8	-1.2	V	VGS = 0V, Is = -150mA
DYNAMIC CHARACTERISTICS (Note 7)					. <		
Input Capacitance		Ciss	_	59.76	-	ρF	
Output Capacitance		Coss	_	12.07	1	pF	$V_{DS} = -16V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance		Crss	_	6.36	_	pF	1 = 1.0W112
Total Gate Charge		Qg	<	622.4		рC	
Gate-Source Charge		Qgs	-	100.3	_	pC	$V_{GS} = -4.5V$ , $V_{DS} = -10V$ ,
Gate-Drain Charge		Qgd	- /	132.2		рС	$I_D = -250 \text{mA}$
Turn-On Delay Time		td(on)	1-1	5.1	4	ns	
Turn-On Rise Time		t <sub>R</sub>	F	8.1		ns	V <sub>DS</sub> = -10V, V <sub>GS</sub> = -4.5V,
Turn-Off Delay Time		t <sub>D(OFF)</sub>		28.4	7	ns	$R_G = 10\Omega$ , $R_L = 47\Omega$
Turn-Off Fall Time		tF	<u> </u>	20.72	<b>\</b> -/	ns	

Notes:

- Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to production testing



#### P-CHANNEL - Q2





#### P-CHANNEL - Q2 (continued)

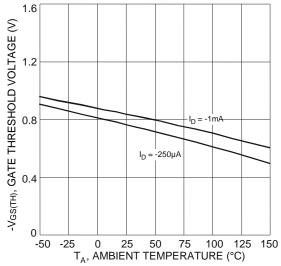
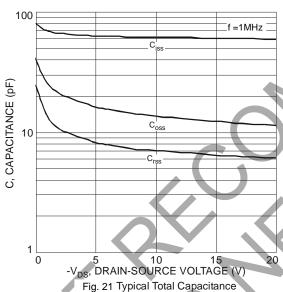


Fig. 19 Gate Threshold Variation vs. Ambient Temperature



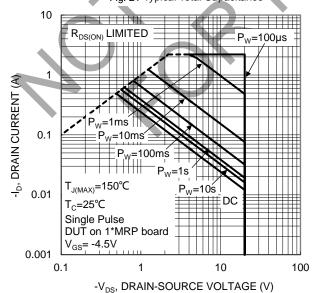


Figure 23. SOA, Safe Operation Area

1.0

0.8

0.8

0.6

0.7

0.2

0.2

0.4

0.6

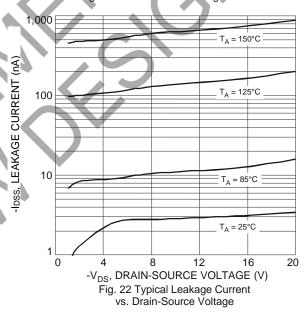
0.8

1.0

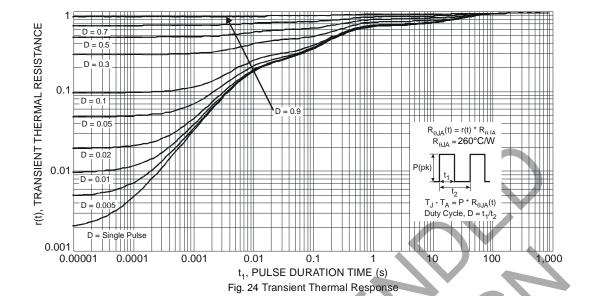
1.2

-V<sub>SD</sub>, SOURCE-DRAIN VOLTAGE (V)

Fig. 20 Diode Forward Voltage vs. Current





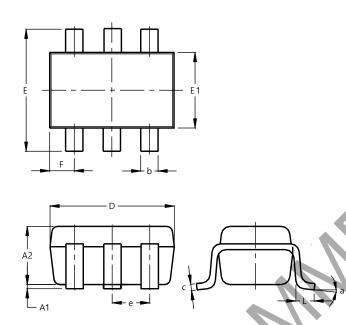




### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT363**

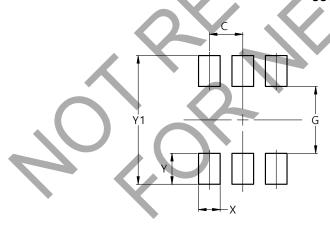


	SO	T363					
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.10	0.30	0.25				
C	0.10	0.22	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
е	0	.650 E	SC				
F	0.40	0.45	0.425				
7	0.25	0.40	0.30				
а	°	å					
All	All Dimensions in mm						

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
X	0.420
Y	0.600
Y1	2 500



#### **IMPORTANT NOTICE**

- 1. DIODES INCORPORATED AND ITS SUBSIDIARIES ("DIODES") MAKE NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO ANY INFORMATION CONTAINED IN THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).
- 2. The Information contained herein is for informational purpose only and is provided only to illustrate the operation of Diodes products described herein and application examples. Diodes does not assume any liability arising out of the application or use of this document or any product described herein. This document is intended for skilled and technically trained engineering customers and users who design with Diodes products. Diodes products may be used to facilitate safety-related applications; however, in all instances customers and users are responsible for (a) selecting the appropriate Diodes products for their applications, (b) evaluating the suitability of the Diodes products for their intended applications, (c) ensuring their applications, which incorporate Diodes products, comply the applicable legal and regulatory requirements as well as safety and functional-safety related standards, and (d) ensuring they design with appropriate safeguards (including testing, validation, quality control techniques, redundancy, malfunction prevention, and appropriate treatment for aging degradation) to minimize the risks associated with their applications.
- 3. Diodes assumes no liability for any application-related information, support, assistance or feedback that may be provided by Diodes from time to time. Any customer or user of this document or products described herein will assume all risks and liabilities associated with such use, and will hold Diodes and all companies whose products are represented herein or on Diodes' websites, harmless against all damages and liabilities.
- 4. Products described herein may be covered by one or more United States, international or foreign patents and pending patent applications. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks and trademark applications. Diodes does not convey any license under any of its intellectual property rights or the rights of any third parties (including third parties whose products and services may be described in this document or on Diodes' website) under this document.
- 5. Diodes products are provided subject to Diodes Standard Terms and Conditions of Sale (https://www.diodes.com/about/company/terms-and-conditions/terms-and-conditions-of-sales/) or other applicable terms. This document does not alter or expand the applicable warranties provided by Diodes. Diodes does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel.
- 6. Diodes products and technology may not be used for or incorporated into any products or systems whose manufacture, use or sale is prohibited under any applicable laws and regulations. Should customers or users use Diodes products in contravention of any applicable laws or regulations, or for any unintended or unauthorized application, customers and users will (a) be solely responsible for any damages, losses or penalties arising in connection therewith or as a result thereof, and (b) indemnify and hold Diodes and its representatives and agents harmless against any and all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim relating to any noncompliance with the applicable laws and regulations, as well as any unintended or unauthorized application.
- 7. While efforts have been made to ensure the information contained in this document is accurate, complete and current, it may contain technical inaccuracies, omissions and typographical errors. Diodes does not warrant that information contained in this document is error-free and Diodes is under no obligation to update or otherwise correct this information. Notwithstanding the foregoing, Diodes reserves the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes.
- 8. Any unauthorized copying, modification, distribution, transmission, display or other use of this document (or any portion hereof) is prohibited. Diodes assumes no responsibility for any losses incurred by the customers or users or any third parties arising from any such unauthorized use.

Copyright © 2022 Diodes Incorporated

www.diodes.com